

IXYN110N120C4H1

1200V, 110A XPT™ Gen4 IGBT with Sonic Diode

Extreme Light Punch Through IGBT for 20–50 kHz Switching



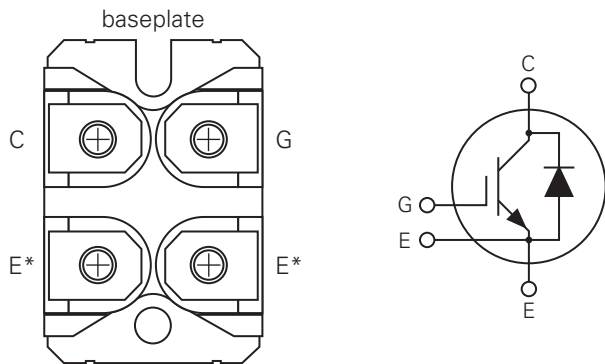
Description:

Developed using our proprietary XPT™ thin-wafer technology and state-of-the-art Trench IGBT process, these devices feature reduced thermal resistance, low energy losses, fast switching, low tail current, and high current densities.

Features & Benefits:

- Optimized for 20–50 kHz Switching
- miniBLOC, with Aluminum Nitride Isolation
- 2500V~ Isolation Voltage
- High Surge Current Capability
- Positive Thermal Coefficient of $V_{CE(sat)}$
- International Standard Package
- Low Gate Charge Q_G
- Anti-Parallel Sonic Diode

Pinout Diagram (SOT-227B)



G: Gate; **C:** Collector; **E:** Emitter; **baseplate:** Isolated
 *Either emitter terminal can be used as Main or Kelvin Emitter

Applications:

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines

Product Summary

| Characteristic | Value | Unit |
|----------------|-------|------|
| V_{CES} | 1200 | V |
| I_{C110} | 110 | A |
| $V_{CE(sat)}$ | 2.40 | V |
| $t_{fi(typ)}$ | 37 | ns |

Maximum Ratings

| Symbol | Characteristic | Conditions | Value | Unit |
|-----------------|---|--|------------|------------------|
| V_{CES} | Collector-Emitter Voltage | $T_J = 25^\circ\text{C}$ to 175°C | 1200 | V |
| V_{GES} | Gate-Emitter Voltage | Continuous | ± 20 | V |
| V_{GEM} | Transient Gate-Emitter Voltage | Transient | ± 30 | V |
| I_{C25} | Continuous Collector Current | $T_C = 25^\circ\text{C}$ | 210 | A |
| I_{LRMS} | Terminal Current Limit | – | 200 | A |
| I_{C110} | Continuous Collector Current | $T_C = 110^\circ\text{C}$ | 110 | A |
| I_{F110} | Diode Forward Current | $T_C = 110^\circ\text{C}$ | 74 | A |
| I_{CM} | Pulsed Collector Current | $T_C = 25^\circ\text{C}$, 1 ms | 760 | A |
| SSOA (RBSOA) | Switching Safe Operating Area (Reverse Biased Safe Operating Area) | $V_{GE} = 15\text{ V}$, $T_{VJ} = 150^\circ\text{C}$, $R_G = 2\ \Omega$, $I_{CM} = 0.8 \times V_{CES}$ | 220 | A |
| P_C | Collector Power Dissipation | $T_C = 25^\circ\text{C}$ | 830 | W |
| T_J | Junction Temperature | – | -55 to 175 | $^\circ\text{C}$ |
| T_{JM} | Maximum Junction Temperature | – | 175 | $^\circ\text{C}$ |
| T_{stg} | Storage Temperature | – | -55 to 175 | $^\circ\text{C}$ |
| V_{ISOL} | Isolation Voltage | 50/60 Hz, $I_{ISOL} \leq 1\text{ mA}$, $t = 1\text{ min}$ | 2500 | V~ |
| | | 50/60 Hz, $I_{ISOL} \leq 1\text{ mA}$, $t = 1\text{ s}$ | 3000 | |
| M_d | Mounting Torque | – | 1.5 / 13 | Nm/lb.in |
| | Terminal Connection Torque | – | 1.3 / 11.5 | |
| W | Weight | – | 30 | g |

Thermal Characteristics

| Symbol | Characteristic | Value | | | Unit |
|--------------|---------------------------------------|-------|------|------|---------------------------|
| | | Min. | Typ. | Max. | |
| $R_{th, JC}$ | Thermal Resistance, junction-to-case | – | – | 0.18 | $^\circ\text{C}/\text{W}$ |
| $R_{th, CS}$ | Thermal Resistance, case-to-heat sink | – | 0.05 | – | $^\circ\text{C}/\text{W}$ |

Electrical Characteristics – Static ($T_J = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Characteristic | Conditions | Value | | | Unit |
|---------------|---|--|-------|------|-----------|---------------|
| | | | Min. | Typ. | Max. | |
| BV_{CES} | Collector-Emitter Breakdown Voltage | $I_C = 250\ \mu\text{A}$, $V_{GE} = 0\text{ V}$ | 1200 | – | – | V |
| $V_{GE(th)}$ | Gate-Emitter Threshold Voltage | $I_C = 3\text{ mA}$, $V_{CE} = V_{GE}$ | 4.5 | – | 6.5 | V |
| I_{CES} | Zero Gate Voltage Collector Current | $V_{CE} = V_{CES}$, $V_{GE} = 0\text{ V}$ | – | – | 50 | μA |
| | | $V_{CE} = V_{CES}$, $V_{GE} = 0\text{ V}$, $T_J = 150^\circ\text{C}$ | – | – | 7 | mA |
| I_{GES} | Gate-Emitter Leakage Current | $V_{CE} = 0\text{ V}$, $V_{GE} = \pm 20\text{ V}$ | – | – | ± 100 | nA |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage ¹ | $I_C = I_{C110}$, $V_{GE} = 15\text{ V}$ | – | 1.90 | 2.40 | V |
| | | $I_C = I_{C110}$, $V_{GE} = 15\text{ V}$, $T_J = 150^\circ\text{C}$ | – | 2.27 | – | V |

Note 1: Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle, $d \leq 2\%$

Electrical Characteristics – Dynamic ($T_J = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Characteristic | Conditions | Value | | | Unit | |
|--------------|----------------------------------|--|---------------------------|------|------|------|----|
| | | | Min. | Typ. | Max. | | |
| g_{fs} | Transconductance ¹ | $I_C = 60\text{ A}, V_{CE} = 10\text{ V}$ | 40 | 68 | – | S | |
| C_{ies} | Input Capacitance | $V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$ | – | 5420 | – | pF | |
| C_{oes} | Output Capacitance | | – | 495 | – | | |
| C_{res} | Reverse Transfer Capacitance | | – | 220 | – | | |
| $Q_{g(on)}$ | Total Gate Charge | $I_C = I_{C110}, V_{GE} = 15\text{ V}, V_{CE} = 0.5 \times V_{CES}$ | – | 330 | – | nC | |
| Q_{ge} | Gate-Emitter Charge | | – | 55 | – | | |
| Q_{gc} | Gate-Collector Charge | | – | 138 | – | | |
| $t_{d(on)}$ | Turn-on Delay Time ² | Inductive Load, $V_{GE} = 15\text{ V},$ $V_{CE} = 0.5 \times V_{CES},$ $I_C = 50\text{ A},$ $R_{G(ext)} = 2\ \Omega$ | $T_J = 25^\circ\text{C}$ | – | 40 | – | ns |
| | | | $T_J = 150^\circ\text{C}$ | – | 36 | – | |
| t_{ri} | Turn-on Rise Time ² | | $T_J = 25^\circ\text{C}$ | – | 48 | – | ns |
| | | | $T_J = 150^\circ\text{C}$ | – | 37 | – | |
| E_{on} | Turn-on Energy ² | | $T_J = 25^\circ\text{C}$ | – | 3.6 | – | mJ |
| | | | $T_J = 150^\circ\text{C}$ | – | 5.3 | – | |
| $t_{d(off)}$ | Turn-off Delay Time ² | | $T_J = 25^\circ\text{C}$ | – | 320 | – | ns |
| | | | $T_J = 150^\circ\text{C}$ | – | 326 | – | |
| t_{fi} | Turn-off Fall Time ² | | $T_J = 25^\circ\text{C}$ | – | 37 | – | ns |
| | | | $T_J = 150^\circ\text{C}$ | – | 90 | – | |
| E_{off} | Turn-off Energy ² | $T_J = 25^\circ\text{C}$ | – | 1.9 | – | mJ | |
| | | $T_J = 150^\circ\text{C}$ | – | 3.2 | – | | |

Note 1: Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle, $d \leq 2\%$

Note 2: Switching times and energy losses may increase for higher $V_{CE(clamp)}$, T_J , or R_G .

Reverse Sonic Diode (FRD) ($T_J = 25^\circ\text{C}$ unless otherwise specified)

| Symbol | Characteristic | Conditions | Value | | | Unit |
|--------------|--------------------------------------|---|-------|------|------|---------------------------|
| | | | Min. | Typ. | Max. | |
| V_F | Diode Forward Voltage ¹ | $I_F = 100\text{ A}, V_{GE} = 0\text{ V}$ | – | 2.20 | 2.70 | V |
| | | $I_F = 75\text{ A}, V_{GE} = 0\text{ V}, T_J = 150^\circ\text{C}$ | – | 2.15 | – | |
| I_{RM} | Reverse Recovery Current | $I_F = 50\text{ A}, V_{GE} = 0\text{ V}, T_J = 150^\circ\text{C}$ | – | 43 | – | A |
| t_{rr} | Reverse Recovery Time | $-di_F/dt = 750\text{ A}/\mu\text{s}, V_R = 600\text{ V}$ | – | 270 | – | ns |
| $R_{th, JC}$ | Thermal Resistance, junction-to-case | – | – | – | 0.41 | $^\circ\text{C}/\text{W}$ |

Note 1: Pulse test, $t \leq 300\ \mu\text{s}$, duty cycle, $d \leq 2\%$

Characteristic Curves

Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

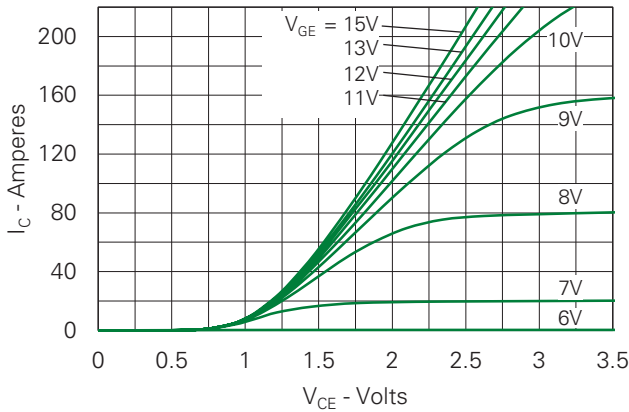


Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

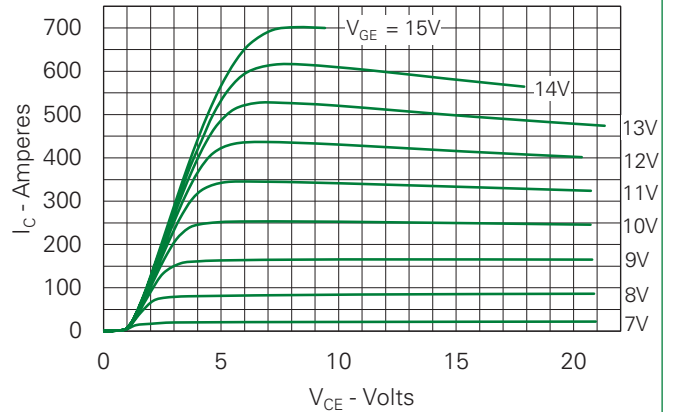


Fig. 3. Output Characteristics @ $T_J = 150^\circ\text{C}$

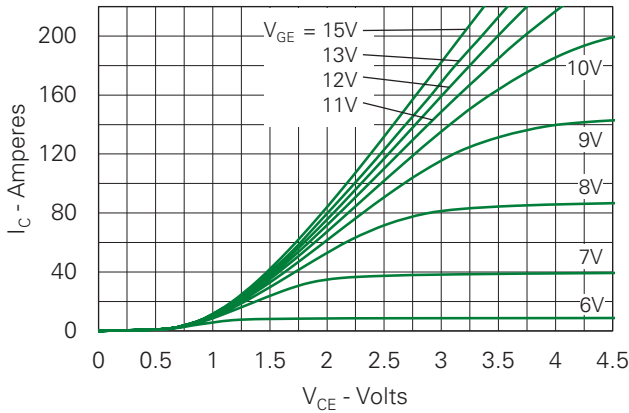


Fig. 4. Dependence of $V_{CE(sat)}$ on Junction Temperature

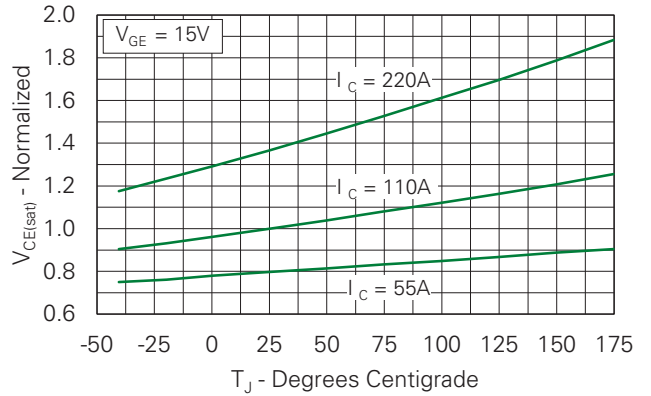


Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

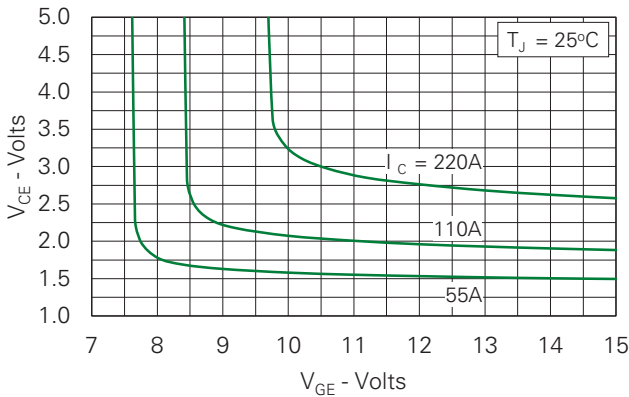


Fig. 6. Input Admittance

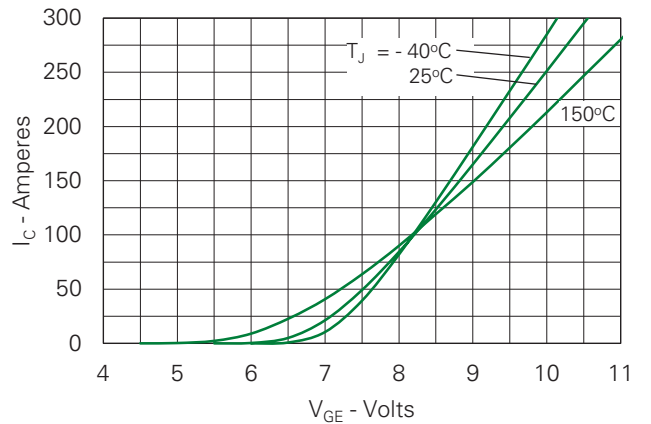


Fig. 7. Transconductance

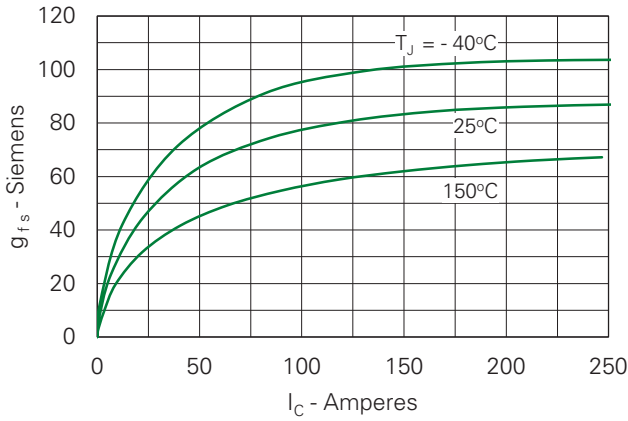


Fig. 8. Gate Charge

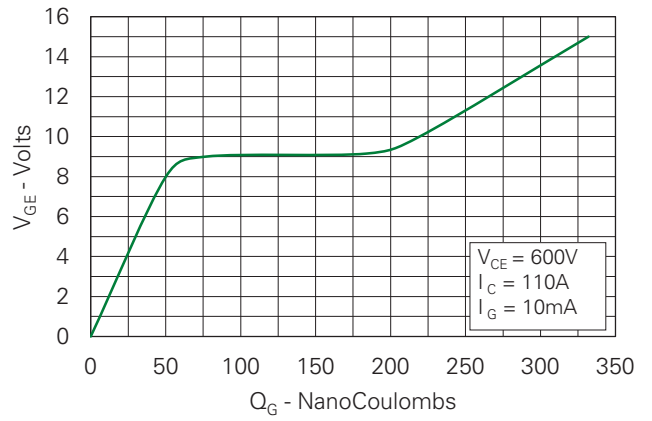


Fig. 9. Capacitance

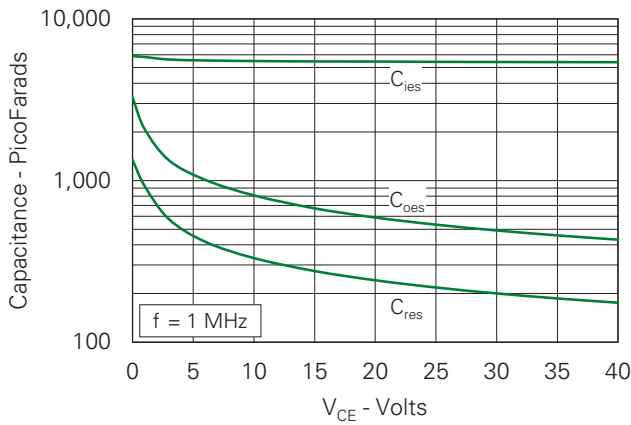


Fig. 10. Reverse-Bias Safe Operating Area

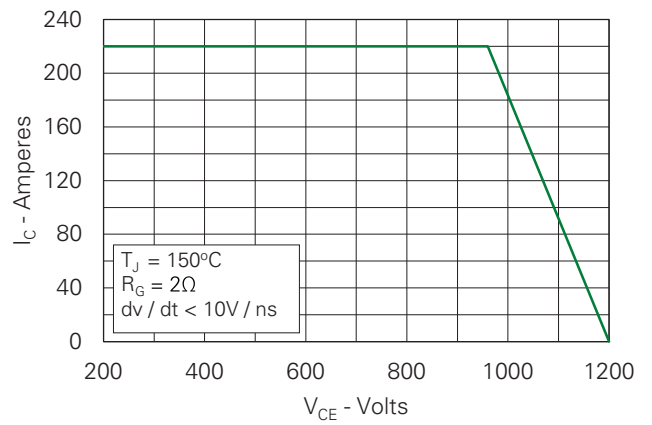


Fig. 11. Maximum Transient Thermal Impedance

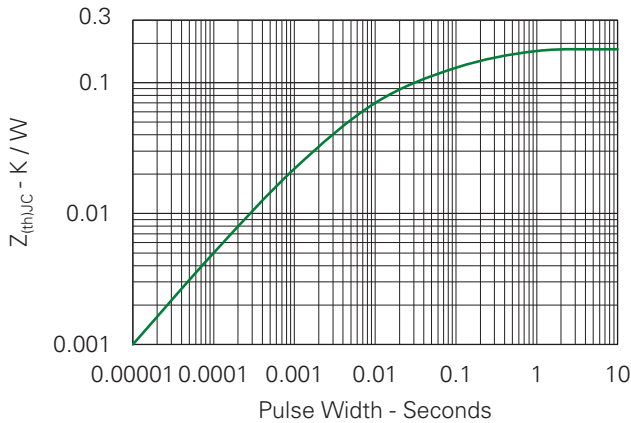


Fig. 12. Inductive Switching Energy Loss vs. Collector Current

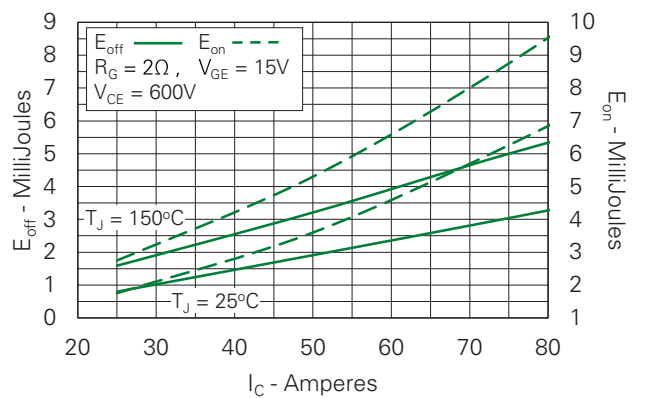


Fig. 13. Inductive Switching Energy Loss vs. Collector-Emitter Voltage

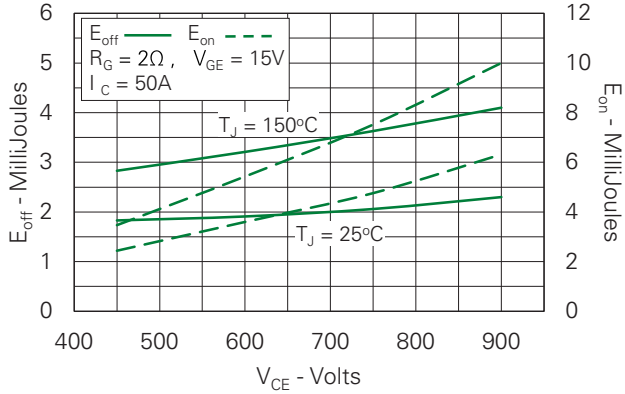


Fig. 14. Inductive Switching Energy Loss vs. Gate Resistance

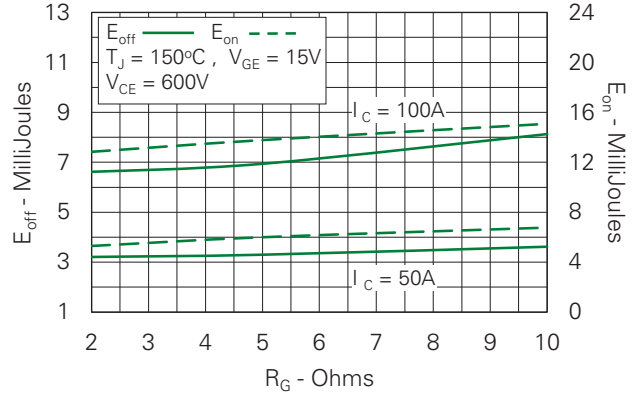


Fig. 15. Inductive Switching Energy Loss vs. Junction Temperature

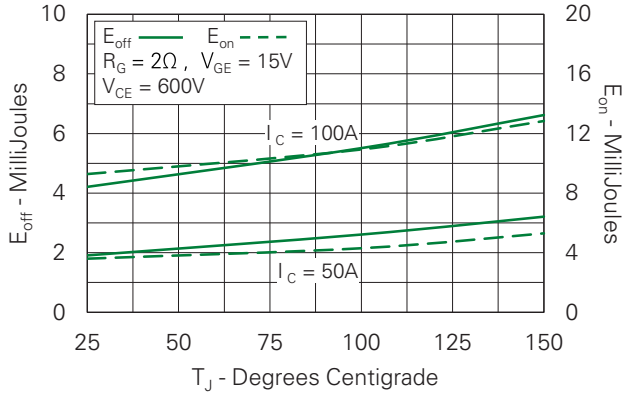


Fig. 16. Inductive Turn-off Switching Times vs. Gate Resistance

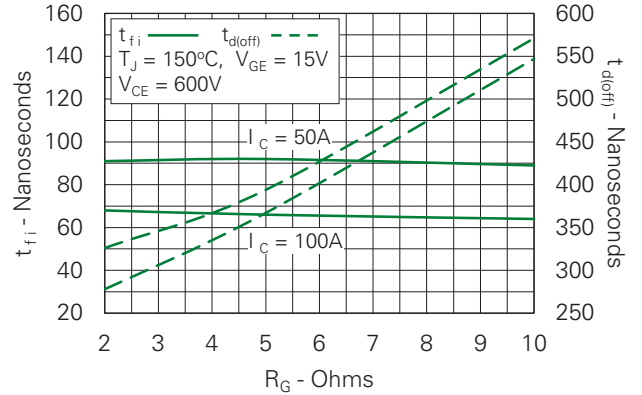


Fig. 17. Inductive Turn-off Switching Times vs. Collector Current

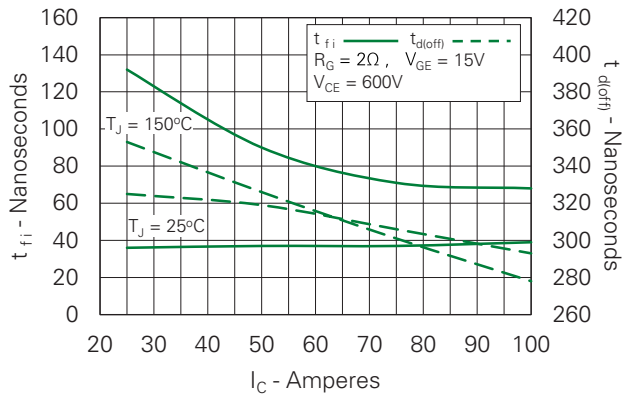


Fig. 18. Inductive Turn-off Switching Times vs. Junction Temperature

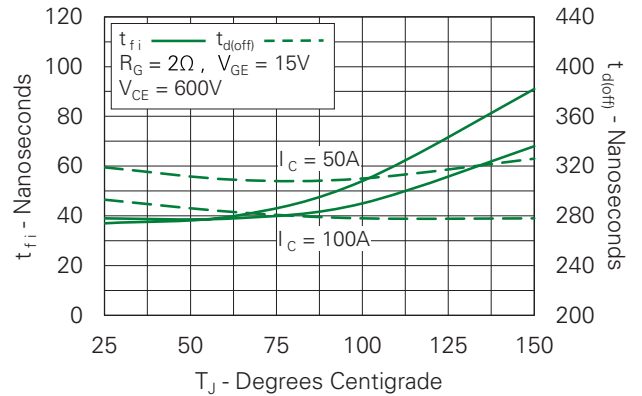


Fig. 19. Inductive Turn-on Switching Times vs. Gate Resistance

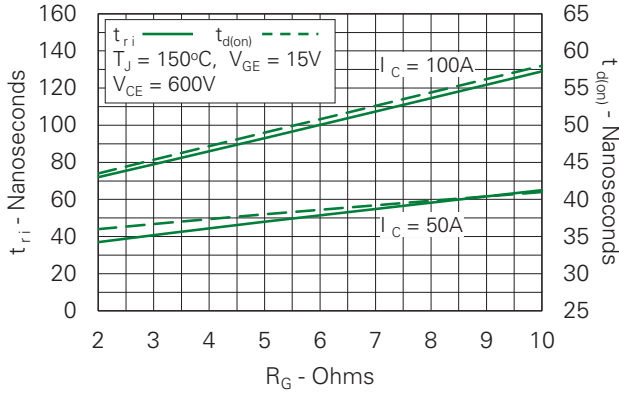


Fig. 20. Inductive Turn-on Switching Times vs. Collector Current

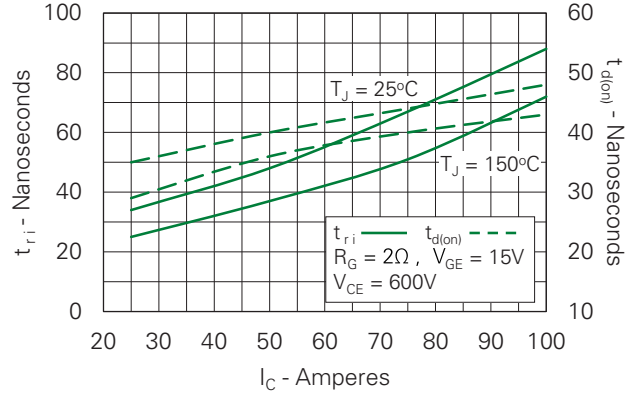


Fig. 21. Inductive Turn-on Switching Times vs. Junction Temperature

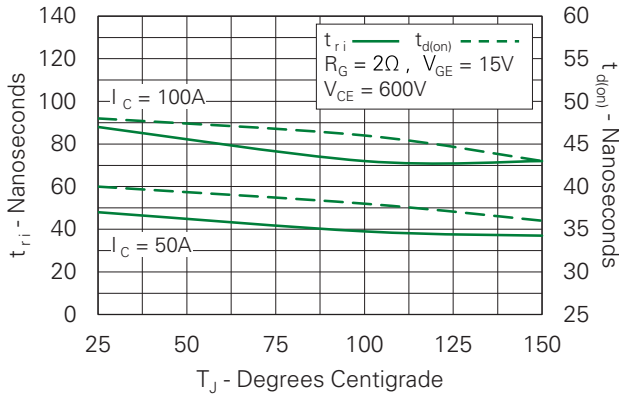


Fig. 22. Maximum Peak Load Current vs. Frequency

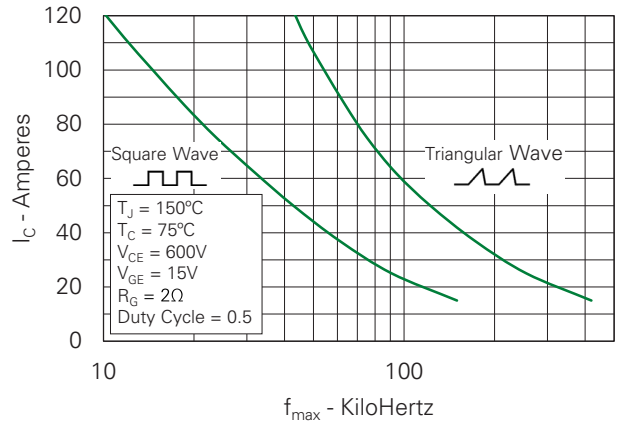


Fig. 23. Diode Forward Characteristics

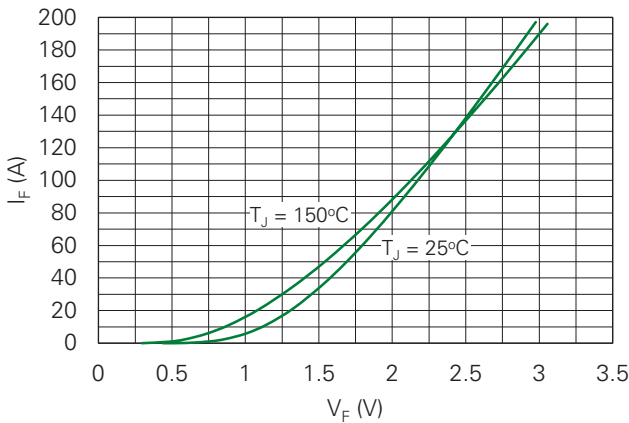


Fig. 24. Reverse Recovery Charge vs. -di_F/dt

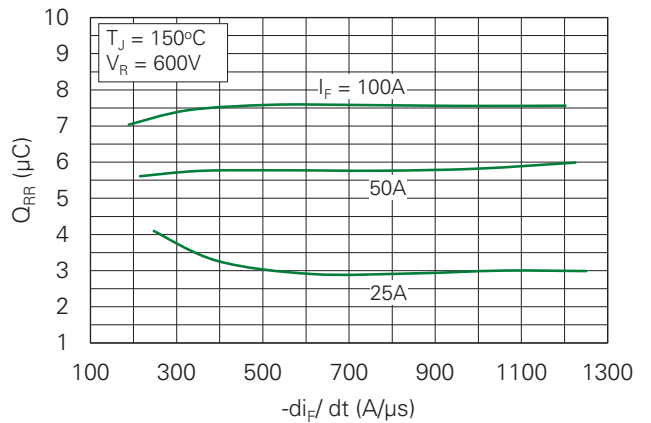


Fig. 25. Reverse Recovery Current vs. $-di_F/dt$

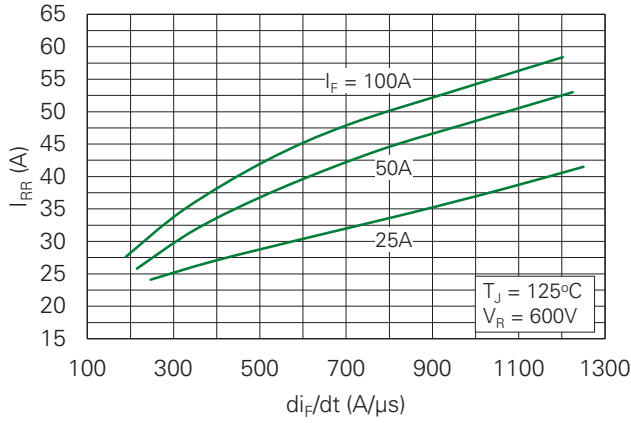


Fig. 26. Reverse Recovery Time vs. $-di_F/dt$

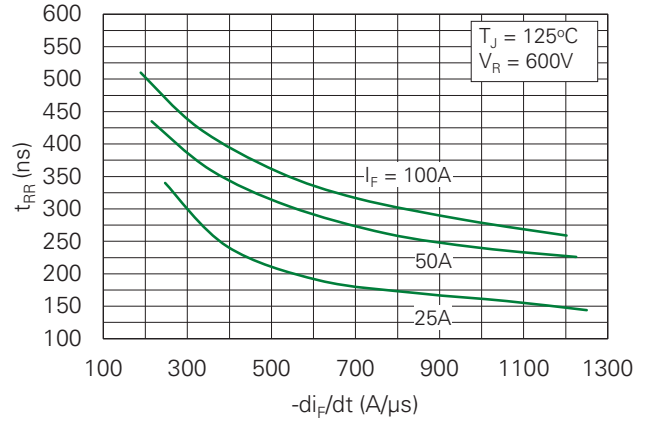


Fig. 27. Dynamic Parameters Q_{RR} , I_{RR} vs. Junction Temperature

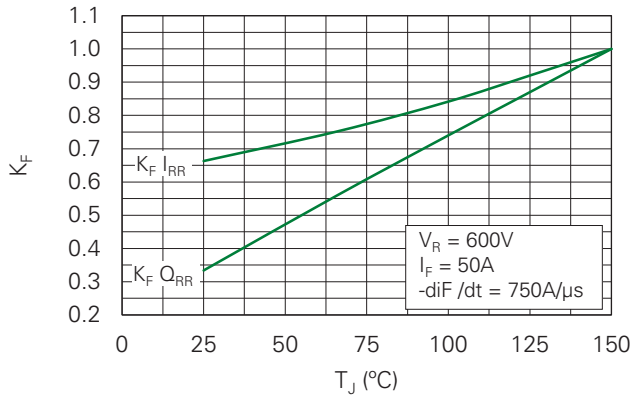
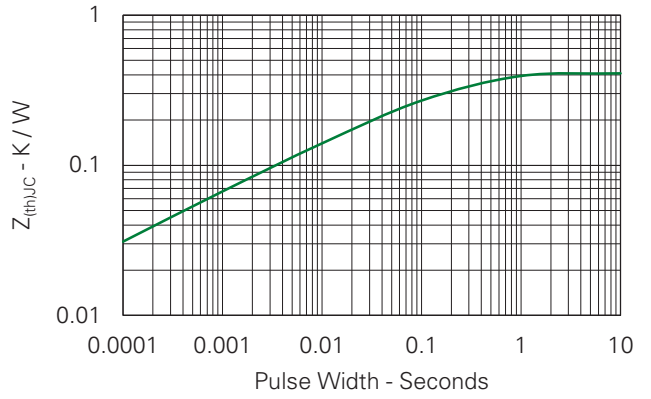
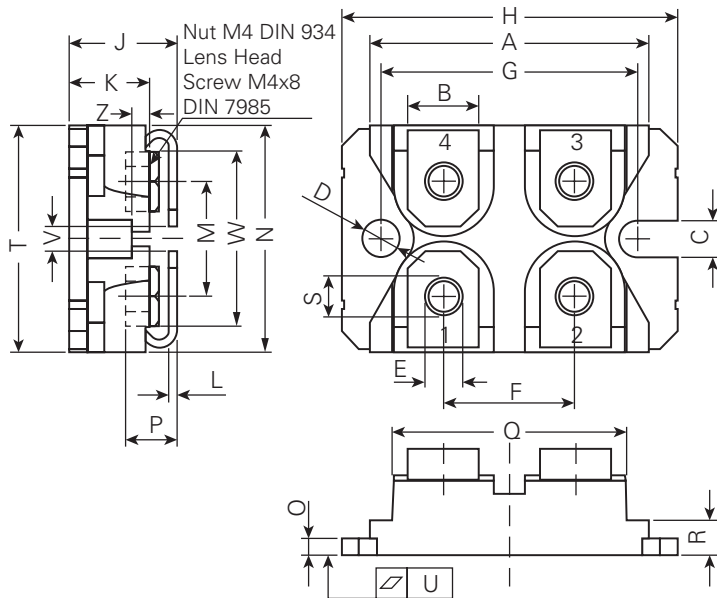


Fig. 28. Maximum Transient Thermal Impedance (Diode)



Part Outline Drawing (SOT-227B)



| Symbol | Inches | | | Millimeters | | |
|--------|--------|---------|-------|-------------|---------|-------|
| | Min. | Typical | Max. | Min. | Typical | Max. |
| A | 1.240 | - | 1.255 | 31.50 | - | 31.88 |
| B | 0.307 | - | 0.323 | 7.80 | - | 8.20 |
| C | 0.161 | - | 0.169 | 4.09 | - | 4.29 |
| D | 0.161 | - | 0.169 | 4.09 | - | 4.29 |
| E | 0.161 | - | 0.169 | 4.09 | - | 4.29 |
| F | 0.587 | - | 0.595 | 14.91 | - | 15.11 |
| G | 1.186 | - | 1.193 | 30.12 | - | 30.30 |
| H | 1.488 | - | 1.505 | 37.80 | - | 38.23 |
| J | 0.460 | - | 0.481 | 11.68 | - | 12.22 |
| K | 0.351 | - | 0.378 | 8.92 | - | 9.60 |
| L | 0.029 | - | 0.033 | 0.74 | - | 0.84 |
| M | 0.492 | - | 0.516 | 12.50 | - | 13.10 |
| N | 0.990 | - | 1.001 | 25.15 | - | 25.42 |
| O | 0.077 | - | 0.084 | 1.95 | - | 2.13 |
| P | 0.195 | - | 0.244 | 4.95 | - | 6.20 |
| Q | 1.045 | - | 1.059 | 26.54 | - | 26.90 |
| R | 0.155 | - | 0.174 | 3.94 | - | 4.42 |
| S | 0.179 | - | 0.191 | 4.55 | - | 4.85 |
| T | 0.968 | - | 0.994 | 24.59 | - | 25.25 |
| U | -0.002 | - | 0.004 | -0.05 | - | 0.10 |
| V | 0.126 | - | 0.217 | 3.20 | - | 5.50 |
| W | 0.780 | - | 0.830 | 19.81 | - | 21.08 |
| Z | 0.098 | - | 0.106 | 2.50 | - | 2.70 |

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